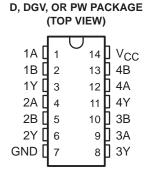
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- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) Submicron Process
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (D), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages



### description

This quadruple 2-input positive-OR gate is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation.

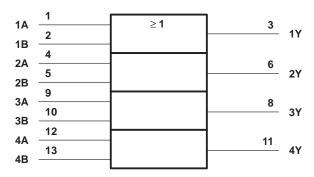
The SN74ALVC32 performs the Boolean function  $Y = \overline{A} \cdot \overline{B}$  or Y = A + B in positive logic.

The SN74ALVC32 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each gate)

INP	JTS	OUTPUT
Α	В	Υ
Н	Х	Н
Х	Н	Н
L	L	L

## logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram, each gate (positive logic)





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TEXAS INSTRUMENTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

0.5 V to V <sub>CC</sub> + 0.5 V
—50 mA
±50 mA
±100 mA
D package 86°C/W
DGV package 127°C/W
PW package 113°C/W

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. This value is limited to 4.6 V maximum.
  - 3. The package thermal impedance is calculated in accordance with JESD 51.

### recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
Vсс	Supply voltage		1.65	3.6	V	
	High-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
ViH		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		V <sub>CC</sub> = 1.65 V to 1.95 V		0.35 × V <sub>CC</sub>		
$\vee_{IL}$	Low-level input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V		0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		
٧ı	Input voltage		0	Vcc	V	
٧o	Output voltage		0	Vcc	V	
	High-level output current	V <sub>CC</sub> = 1.65 V		-4		
1		V <sub>CC</sub> = 2.3 V		-12	A	
ЮН		V <sub>CC</sub> = 2.7 V		-12	mA	
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
	Low-level output current	V <sub>CC</sub> = 2.3 V		12	mA	
lOL		V <sub>CC</sub> = 2.7 V		12		
		V <sub>CC</sub> = 3 V		24		
Δt/Δν	Input transition rise or fall rate		0	5	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	ONDITIONS	VCC	MIN	TYP†	MAX	UNIT
	$I_{OH} = -100 \mu\text{A}$		1.65 V to 3.6 V	V <sub>CC</sub> -0.	2		
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2				
	I <sub>OH</sub> = -6 mA		2.3 V	2			
Voн			2.3 V	1.7			V
	I <sub>OH</sub> = -12 mA		2.7 V	2.2			
			3 V	2.4			
	I <sub>OH</sub> = -24 mA		3 V	2			
	$I_{OL} = 100 \mu\text{A}$		1.65 V to 3.6 V			0.2	
	I <sub>OL</sub> = 4 mA		1.65 V			0.45	
V <sub>OL</sub>	I <sub>OL</sub> = 6 mA		2.3 V			0.4	V
VOL	I <sub>OL</sub> = 12 mA	2.3 V			0.7	v	
	IOL = 12 IIIA		2.7 V			0.4	
	I <sub>OL</sub> = 24 mA		3 V			0.55	
lį	$V_I = V_{CC}$ or GND		3.6 V			±5	μΑ
Icc	$V_I = V_{CC}$ or GND,	IO = 0	3.6 V			10	μΑ
ΔlCC	One input at V <sub>CC</sub> – 0.6 V,	Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			750	μΑ
C <sub>i</sub>	$V_I = V_{CC}$ or GND		3.3 V		4		pF

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

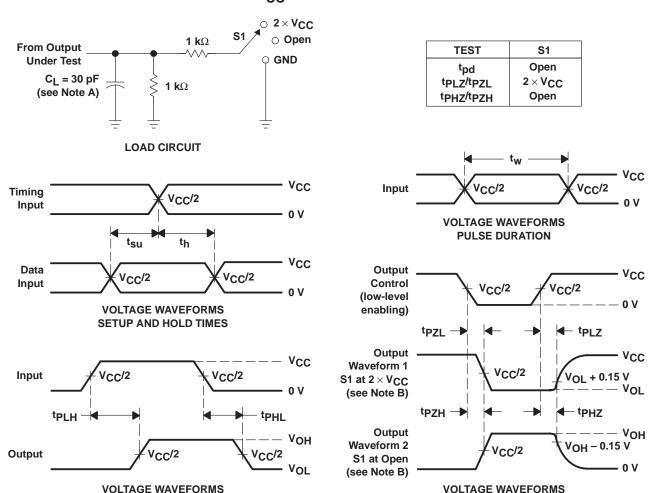
# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)		V <sub>CC</sub> = 1.8 V ± 0.15 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> pd	A or B	Υ	1	4.7	1	3.1		2.9	1	2.8	ns

## operating characteristics, T<sub>A</sub> = 25°C

PARAMETER		TEST CONDITIONS		V <sub>CC</sub> = 1.8 V ± 0.15 V	V <sub>CC</sub> = 2.5 V ± 0.2 V	V <sub>CC</sub> = 3.3 V ± 0.3 V	UNIT
				TYP	TYP	TYP	
C <sub>pd</sub>	Power dissipation capacitance per gate	$C_L = 0$ ,	f = 10 MHz	23	24	26	pF

## PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

**ENABLE AND DISABLE TIMES** 

- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq$  2 ns.  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.

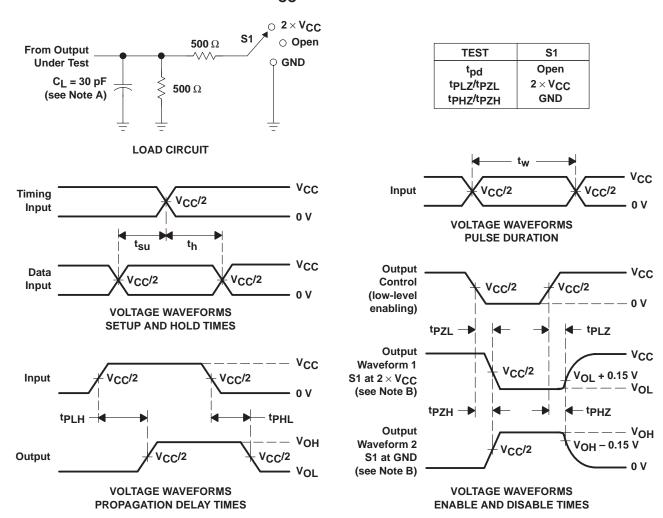
**PROPAGATION DELAY TIMES** 

- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



# PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

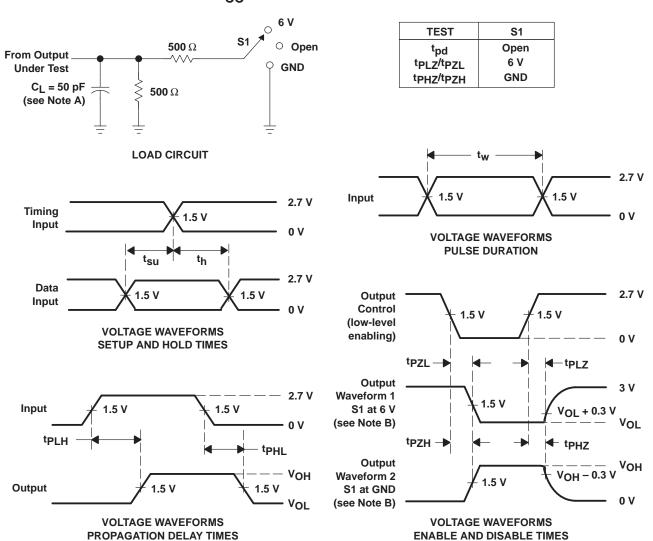


NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2 ns.  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms

# PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 2.7 V AND 3.3 V $\pm$ 0.3 V



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR $\leq$ 10 MHz,  $Z_O$  = 50  $\Omega$ ,  $t_f\leq$ 2.5 ns.  $t_f\leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F. tpZL and tpZH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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